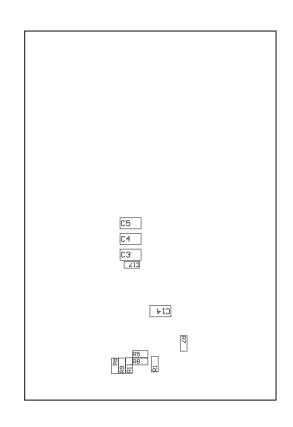


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP20721	REV: A	SUN REV:	Not In VersionControl	
	TID #: N/A				
PLOT NAME = Top Assembly Drawing	GENERATED : 1/17/2	017 3:48:24	PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP20721	REV: A	SUN REV	Not In VersionControl	
	TID #: N/A				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 1/17/20	017 3:48:26	PM	TEXAS INSTRUMENTS	

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